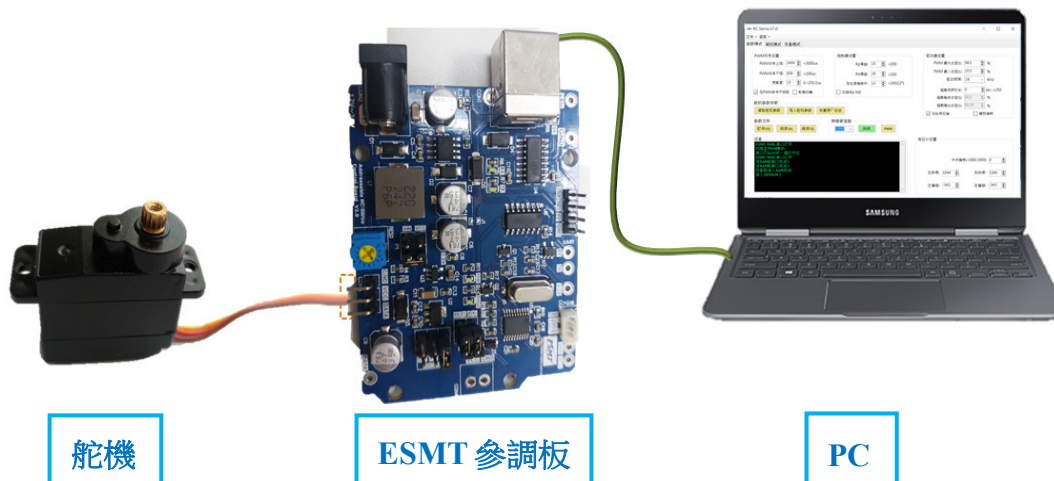


RC_Servo 更新程序 BIN 檔操作步驟

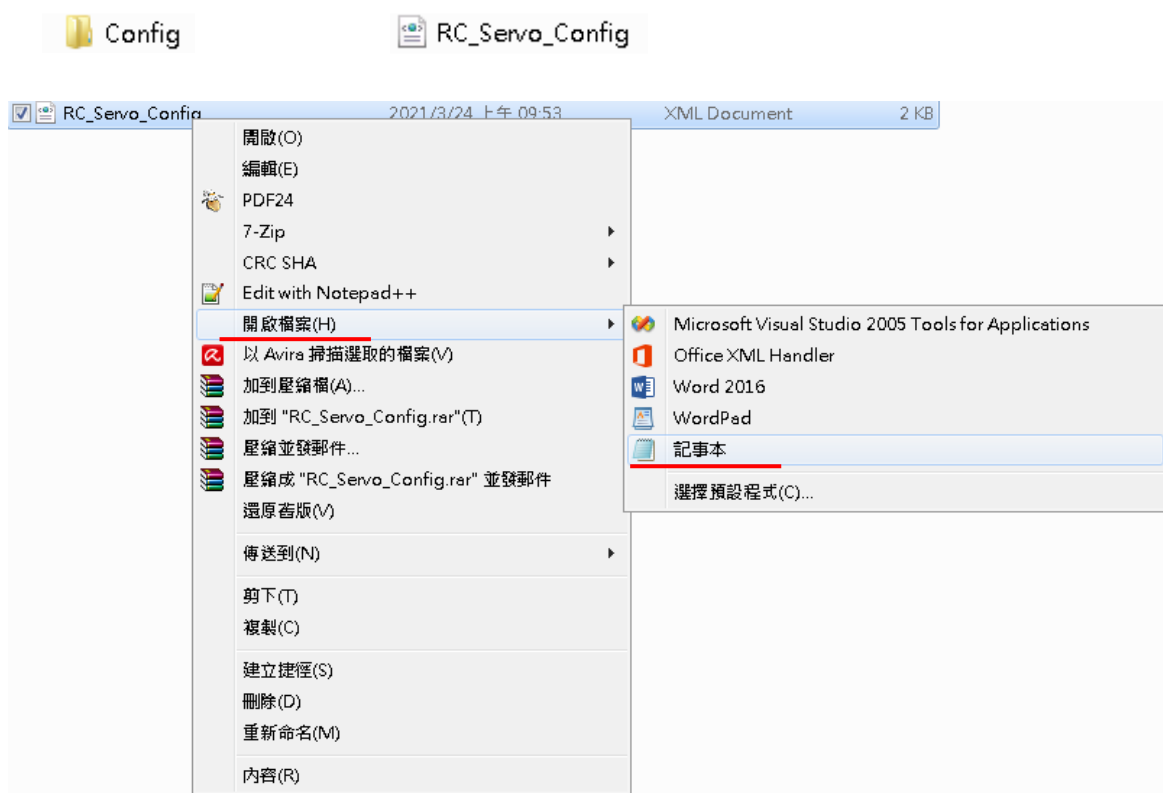
步驟一：

硬體連接裝配圖示



步驟二：

打開”Config”資料夾；點選”RC_Servo_Config”並且點擊右鍵滑鼠鍵，選擇記事本打開文件



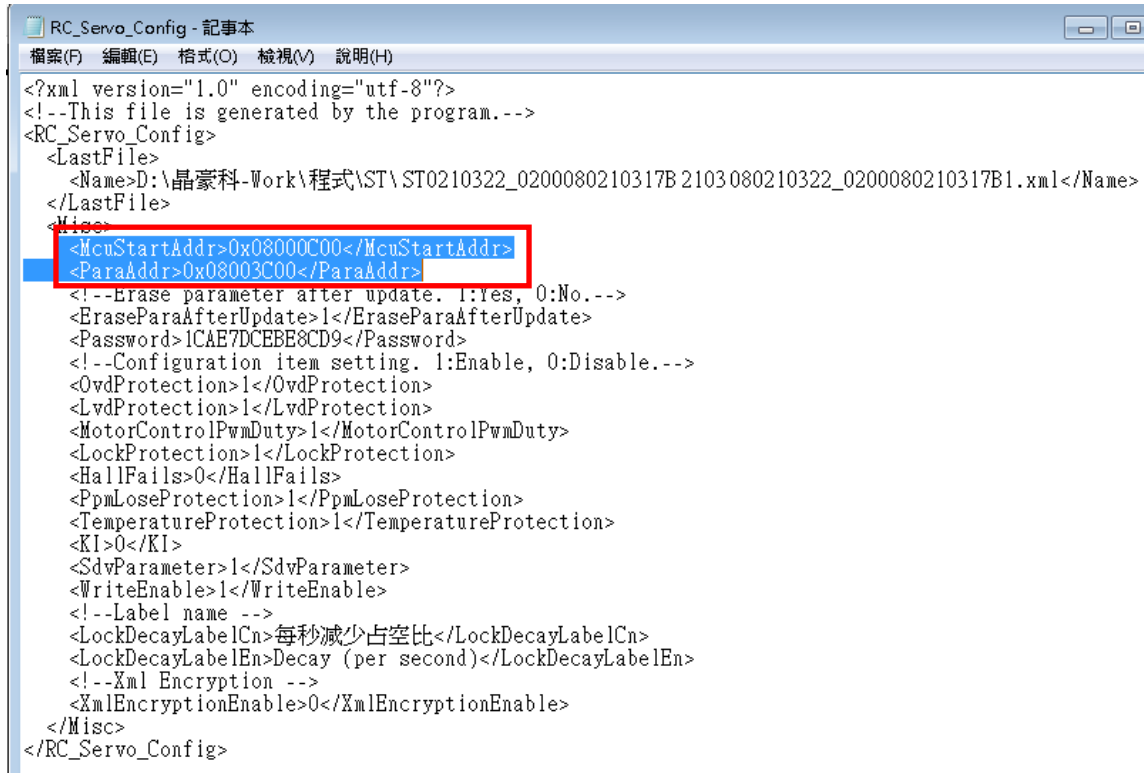
步驟三：

當舵機控制板為空心杯[16K]時，程序位址修改成<McuStartAddr>0x08000C00</McuStartAddr>

<ParaAddr>0x08003C00</ParaAddr>

當舵機控制板為無刷[32K]時，程序位址修改成<McuStartAddr>0x08000C00</McuStartAddr>

<ParaAddr>0x08007C00</ParaAddr>



```
<?xml version="1.0" encoding="utf-8"?>
<!--This file is generated by the program.-->
<RC_Servo_Config>
  <LastFile>
    <Name>D:\晶豪科-Work\程式\ST\ST0210322_0200080210317B 2103 080210322_0200080210317B1.xml</Name>
  </LastFile>
  <McuStartAddr>0x08000C00</McuStartAddr>
  <ParaAddr>0x08003C00</ParaAddr>
  <!--Erase parameter after update. 1:Yes, 0:No.-->
  <EraseParaAfterUpdate>1</EraseParaAfterUpdate>
  <Password>1CAE7DCEBE8CD9</Password>
  <!--Configuration item setting. 1:Enable, 0:Disable.-->
  <OvdProtection>1</OvdProtection>
  <LvdProtection>1</LvdProtection>
  <MotorControlPwmDuty>1</MotorControlPwmDuty>
  <LockProtection>1</LockProtection>
  <HallFails>0</HallFails>
  <PpmLoseProtection>1</PpmLoseProtection>
  <TemperatureProtection>1</TemperatureProtection>
  <KI>0</KI>
  <SdvParameter>1</SdvParameter>
  <WriteEnable>1</WriteEnable>
  <!--Label name -->
  <LockDecayLabelCn>每秒減少占空比</LockDecayLabelCn>
  <LockDecayLabelEn>Decay (per second)</LockDecayLabelEn>
  <!--Xml Encryption -->
  <XmlEncryptionEnable>0</XmlEncryptionEnable>
</Misc>
</RC_Servo_Config>
```

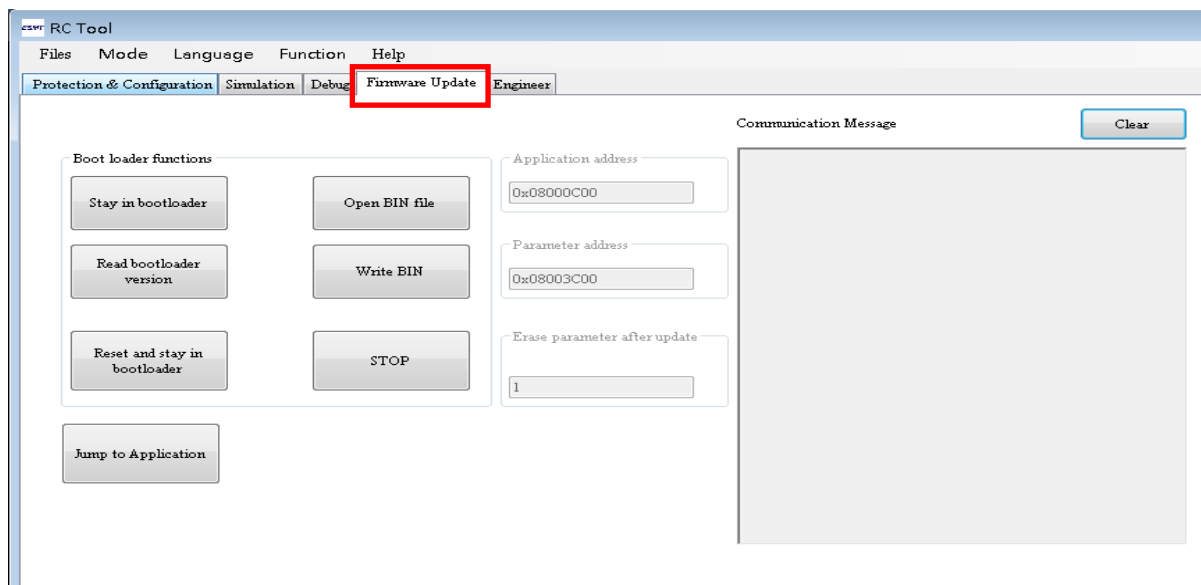
更改完成後，按下儲存並且離開

步驟四：

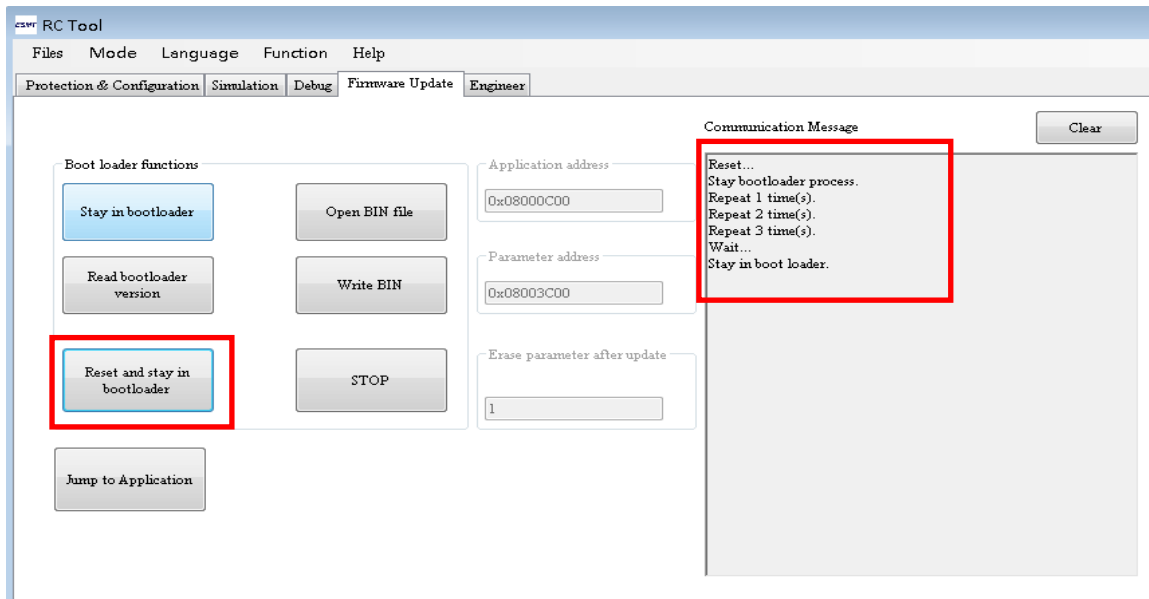
打開 APP ”RC Tool_201012_0028” 進入參調介面

RC Tool_201012_0028

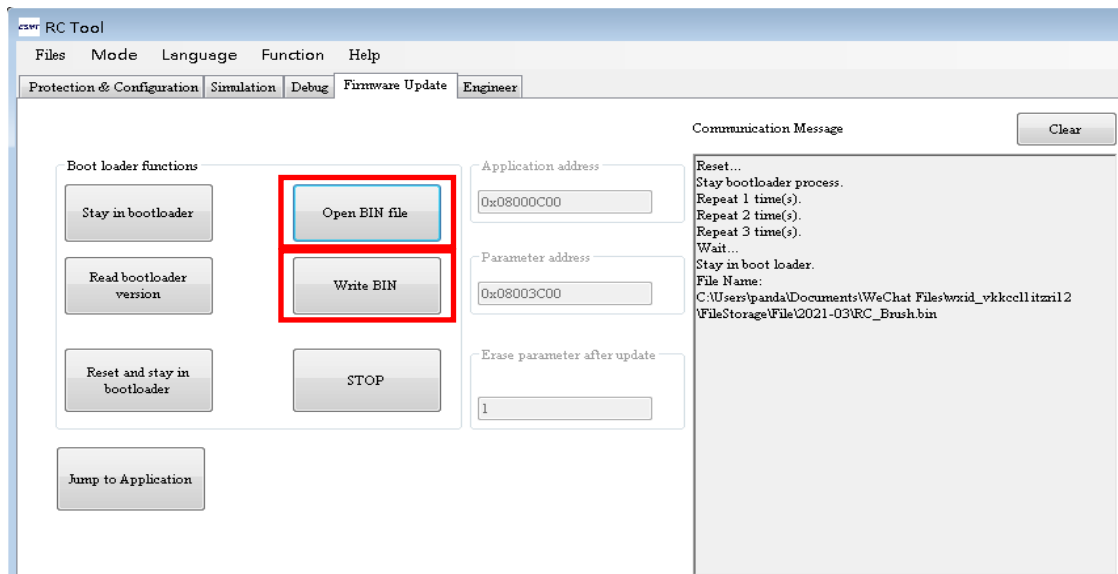
參調板與舵機控制板連接後，點選”Firmware Update”



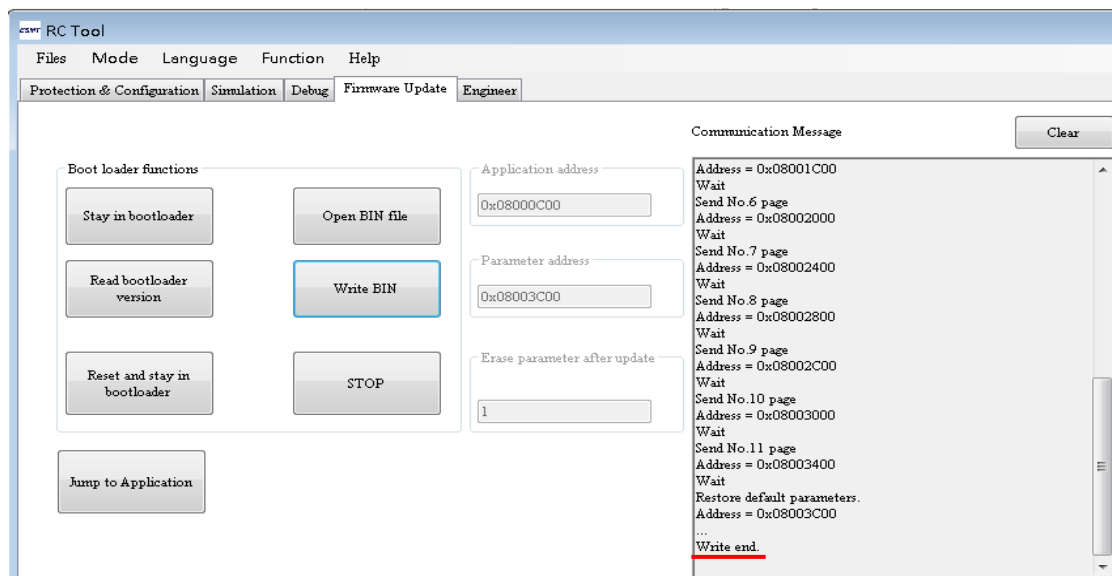
點選”Reset and stay in bootloader” 右邊訊息欄會出現訊息 Stay in boot loader，表示成功



接著點選”Open BIN file”載入要燒錄的 BIN 程序檔後；並點選”Write BIN”開始更新程序



更新完成後，訊息欄會出現 Write end.



最後點選”Jump to Application”離開，完成整個程序更新

